

Electronic Acknowledgement Receipt

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First Named Inventor/Applicant Name:	Zheng Yuan
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File Listing:					
Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1		3rd_SIDS_w_RCE_016301-052200US_61407212_1.pdf	249044	yes	9
			7f9d4d254ceddc3d9a53dfae5887590ab59907d2f		

Multipart Description/PDF files in .zip description					
Document Description			Start	End	
Information Disclosure Statement Letter			1	2	
Information Disclosure Statement (IDS) Filed			3	9	
Warnings:					
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2	Foreign Reference	CA479107.pdf	1516933 6d2f23d30a79617644c2b5ab8ec9f5b241cb61a0	no	28
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3	Foreign Reference	EP0520519.pdf	2503701 dc5e28e4f3c3d4719d5445644cc85e0b6b732b4	no	34
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4	Foreign Reference	JP_1294868_Engabstract.pdf	95851 d9d6ba40d6df2e72ee28c343a5e76a7f06657b	no	2
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6	Foreign Reference	JP4154116.pdf	702119 1cd16c3c64dce997d70c5f1a549ed9614b61627b	no	13
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7	Foreign Reference	JP_11176593_Engabstract.pdf	157306 fa5640dc259312956634a0b07d0e8124d0c02d47f	no	2
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8	Foreign Reference	TW479315B.pdf	395393 9ff80697adce82b71a526c69799560dbab33c8	no	6
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9	Foreign Reference	WO9925895.pdf	2845108 ca54967bd74bdc00e8bd3a14d9e81a877b6ba	no	57
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10	NPL Documents	SACVD_Applied_Materials_website.pdf	90139 46a46d49f5eeebd3a05f460be3468340d95ca3ab	no	2
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11	NPL Documents	BAKER_STI_TEOS_densification.pdf	435857 0c15533a53593a0a057d5c71533c1da3c837b0571	no	7
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12	NPL Documents	Bang_et_al.pdf	640392 29744c0fe057285bda977e8aed54e4be87225747	no	9
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13	NPL Documents	Furnace_definitions.pdf	55458 ecfb00da64c901763e7da8d85acc4211850c418ad	no	1
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14	NPL Documents	Fujino_DependenceofDeposition.pdf	445791 762f40de9ad12abd19f5a6e0cece08a1a9c69225	no	5
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15	NPL Documents	Kuo_EtchMechanism.pdf	268855 8896620c119eb76efcc523c872375647bcb812	no	3
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16	NPL Documents	Kwok-P2172-Surface_Related-J_Electrochem_Soc-V141-N8-1994.pdf	602975 7d5351ccad47b48b000032f6cd0da8da29a0f519	no	6
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18	NPL Documents	Li_ModelingStudies.pdf	159642 61596b624b068b215e2b721c8a011397 4dce828	no	3
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19	NPL Documents	Machida-P818-Si02-J_Vac_Sci_Technol_B-V4-N4-1986.pdf	382854 c8b5f62b970471a67497560b3c5d5b819 a6303a81	no	4
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